Rev. A1

# **SMB1N-700D**

- High Power LED
- 700 nm, 200 mW
- SMD package, PA9T

• Dimension: 5.0 x 5.2 x 1.0 mm

• Viewing Angle: 128°





## Description

**SMB1N-700D** is a surface mount AlGaInP High Power LED with a typical peak wavelength of **700 nm** and radiation of **200 mW**. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

### Maximum Ratings (TCASE=25°C)

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Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	$P_D$		1200	mW	
Forward Current	IF		500	mA	
Pulse Forward Current *1	I <sub>FP</sub>		2000	mA	
Reverse Voltage	<b>V</b> <sub>R</sub>		5	V	
Thermal Resistance	RTHJA		10	K/W	
Junction Temperature	$T_J$		120	°C	
Operating Temperature	$T_{CASE}$	- 40	+ 100	°C	
Storage Temperature	T <sub>STG</sub>	- 40	+ 100	°C	
Lead Solder Temperature *2	$T_{SLD}$		+ 250	°C	

<sup>\*1</sup> duty=1%, pulse width = 10 µs

## Electro-Optical Characteristics (TCASE=25°C)

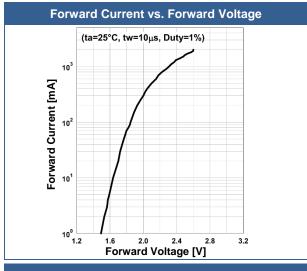
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	$\lambda_P$	I <sub>F</sub> =500mA	690		710	nm
Half Width	$\Delta \lambda$	I <sub>F</sub> =500mA		19		nm
Forward Voltage	VF	I <sub>F</sub> =500mA		2.1	2.3	V
	$V_{FP}$	I <sub>FP</sub> =2A		2.6		V
Radiated Power *1	Po	I <sub>F</sub> =500mA		200		mW
Radiated Fower		I <sub>FP</sub> =2A		770		IIIVV
Radiant Intensity *2	lE	I <sub>F</sub> =500mA		66		mW/sr
Radiant intensity		I <sub>FP</sub> =2A		250		11100/51
Viewing Angle	φ	I <sub>F</sub> =100mA		128		deg.
Rise Time	<i>t</i> <sub>R</sub>	I <sub>F</sub> =500mA		40		ns
Fall Time	t⊧	I <sub>F</sub> =500mA		50		ns

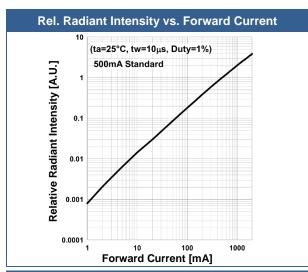
<sup>\*1</sup> measured by S3584-08

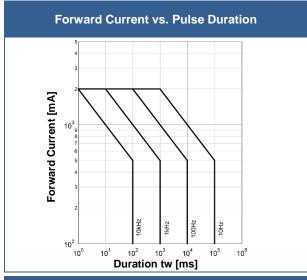
<sup>\*2</sup> must be completed within 5 seconds

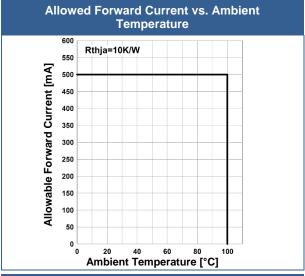
<sup>&</sup>lt;sup>\*2</sup> measured by CIE127-2007 Condition B

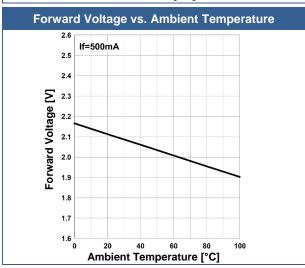
## **Typical Performance Curves**

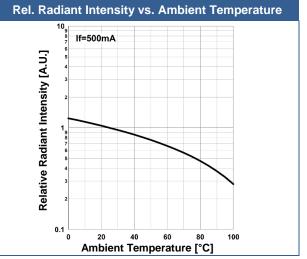










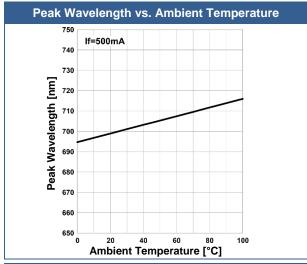


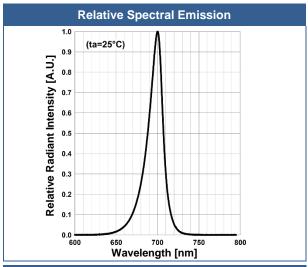


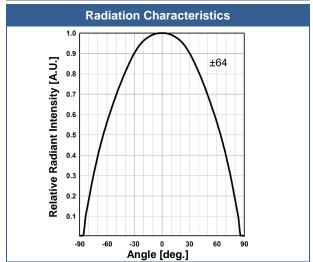
# ROITHNER LASERTECHNIK GmbH

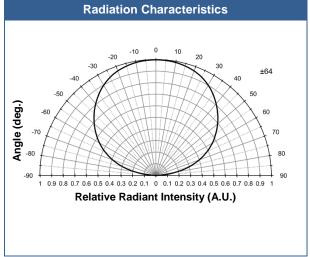
WIEDNER HAUPTSTRASSE 76 IO40 VIENNA AUSTRIA TEL. +43 I 586 52 43 -0, FAX. -44 OFFICE@ROITHNER-LASER.COM



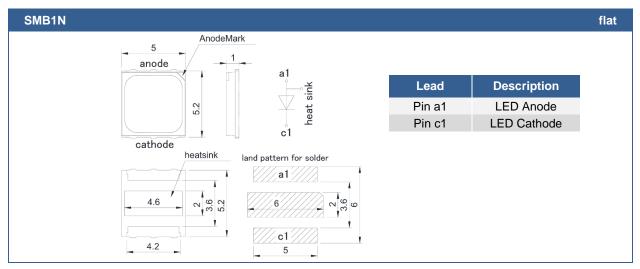








## **Outline Dimensions**



All Dimensions in mm

#### **Precautions**

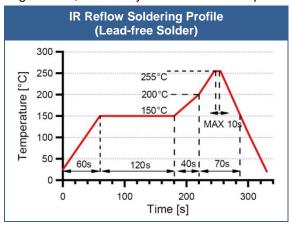
#### Soldering:

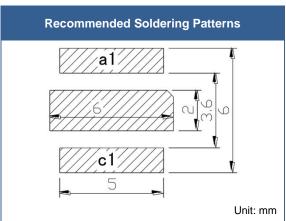
- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

#### Recommended soldering conditions:

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.





Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS

DO NOT USE ultrasonic cleaners

#### Static Electricity:

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

#### Operation:

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

## **Revisions History**

Rel.	Rel. Date	Chapter	Modification	Page
A1	2020-09-30	-	Initial release	-

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The above specifications are for reference purpose only and subjected to change without prior notice